QSFP-DD-400G-LR8

400GBase-LR8 QSFP-DD Optical Transceiver

Hot Pluggable, +3.3V, LC, 1310nm, SMF, 10km, Commercial Temperature

FEATURES

- Compliant with IEEE 802.3bs standard:
  - 400GBASE-LR8 optical interface
  - 400GAUI-8 electrical interface
- Compliant with QSFP-DD MSA HW Rev 5.0 with duplex LC connector
- Compliant with QSFP-DD CMIS Rev 4.0
- Two wire serial Interface with digital diagnostic monitoring
- Complies with EU Directive 2011/65/EU (RoHS compliant)
- Class 1 Laser
- Commercial Operating Temperature Range: 0 to 70ºC

APPLICATIONS

- 400GBASE-LR8 Ethernet
- Telecom Networking
- Data Centre Interconnect

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	T_S	-40		85	ºC	
Supply Voltage	V_{CC}	-0.5		3.6	V	
Relative Humidity (non-condensing)	RH	5		95	%	
Data Input Voltage Differential	$\|V_{DIP}-V_{DIN}\|$	-		1	V	
Control Input Voltage	V_I	-0.3		V_{CC}+0.5	V	
Control Output Current	I_O	-20		20	mA	

RECOMMENDED OPERATING ENVIRONMENT

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case Temperature	T_{OPR}	0	-	70	ºC	
Power Supply Voltage	V_{CC}	3.135	3.3	3.465	V	
Instantaneous peak current at hot plug	I_{CC_IP}	-	-	5600	mA	
Sustained peak current at hot plug	I_{CC_SP}	-	-	4620	mA	
Maximum Power Dissipation	P_D	-	-	14	W	1
Maximum Power Dissipation, Low Power Mode	P_{DLP}	-	-	1.5	W	
Signalling Speed per Lane	DRL	-	26.5625	-	GBd	
Control Input Voltage High	V_{IH}	V_{CC}*0.7	-	V_{CC}+0.3	V	
Control Input Voltage Low	V_{IL}	-0.3	-	V_{CC}*0.3	V	
Two Wire Serial Interface Clock Rate	-	-	-	400	kHz	
Power Supply Noise	-	-	-	66	mVpp	
Rx Differential Data Output Load	-	-	100	-	Ohm	
Operating Distance	-	2	-	10000	m	

Note:

1. Power class 7 module as per QSFP-DD MSA HW specification

OPTICAL PARAMETERS

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
TRANSMITTER						
Wavelength L0	λ_{C0}	1272.55	1273.55	1274.54	nm	
Wavelength L1	λ_{C1}	1276.89	1277.89	1278.89	nm	
Wavelength L2	λ_{C2}	1281.25	1282.26	1283.27	nm	
Wavelength L3	λ_{C3}	1285.65	1286.67	1287.68	nm	
Wavelength L4	λ_{C4}	1294.53	1295.56	1296.59	nm	
Wavelength L5	λ_{C5}	1299.02	1300.06	1301.09	nm	
Wavelength L6	λ_{C6}	1303.54	1304.59	1305.63	nm	
Wavelength L7	λ_{C7}	1308.09	1309.14	1310.19	nm	
Side Mode Suppression Ratio	SMSR	30	-	-	dB	
Total Average Launch Power	AOP_T	-	-	13.2	dBm	
Average Launch Power, each lane	AOP_L	-2.8	-	5.3	dBm	1
Outer Optical Modulation Amplitude (OMAouter), each Lane	T_{OMA}	0.2	-	5.7	dBm	
Difference in Launch Power between any two Lanes (OMAouter)	D_{T_OMA}	-	-	4	dB	
Launch Power in OMAouter minus TDECQ, each lane	$T_{OMA-TDECQ}$	-1.2	-	-	dBm	
Transmitter and Dispersion Eye Closure for PAM4 (TDECQ), each lane	TDECQ	-1.1	-	-	dB	
TDECQ –10log10(Ceq)	-	-	-	3.1	dB	
Average Launch Power of OFF Transmitter, each lane	T_{OFF}	-	-	-30	dBm	
Extinction Ratio	ER	3.5	-	-	dB	

CONTINUED

$RIN_{15}OMA$	RIN	-	-	-132	dB/Hz	
Optical Return Loss Tolerance	ORL	-	-	15.1	dB	
Transmitter Reflectance	T_R	-	-	-26	dB	2
RECEIVER						
Wavelength L0	λ_{C0}	1272.55	1273.55	1274.54	nm	
Wavelength L1	λ_{C1}	1276.89	1277.89	1278.89	nm	
Wavelength L2	λ_{C2}	1281.25	1282.26	1283.27	nm	
Wavelength L3	λ_{C3}	1285.65	1286.67	1287.68	nm	
Wavelength L4	λ_{C4}	1294.53	1295.56	1296.59	nm	
Wavelength L5	λ_{C5}	1299.02	1300.06	1301.09	nm	
Wavelength L6	λ_{C6}	1303.54	1304.59	1305.63	nm	
Wavelength L7	λ_{C7}	1308.09	1309.14	1310.19	nm	
Damage Threshold, each Lane	AOP_D	6.3	-	-	dBm	
Average Receive Power, each Lane	AOP_R	-9.1	-	5.3	dBm	
Receive Power (OMAouter), each Lane	OMA_R	-	-	5.7	dBm	
Difference in Receive Power between any two Lanes (OMAouter)	D_{R_OMA}	-	-	4.5	dB	
Receiver Reflectance	RR	-	-	-26	dB	
Receiver Sensitivity (OMAouter), each Lane	S_{OMA}	-	-	-7.1	dBm	3
Stressed Receiver Sensitivity (OMAouter), each Lane	SRS	-	-	-4.7	dBm	4

Note:

1. Average launch power, each lane (min) is informative and not the principal indicator of signal strength
2. Transmitter reflectance is defined looking into the transmitter
3. Receiver sensitivity (OMAouter), each lane (max) is informative and is defined for a transmitter with SECQ of 0.9dB
4. Measured with conformance test signal at TP3 for the BER = $2.4x10^{-4}$

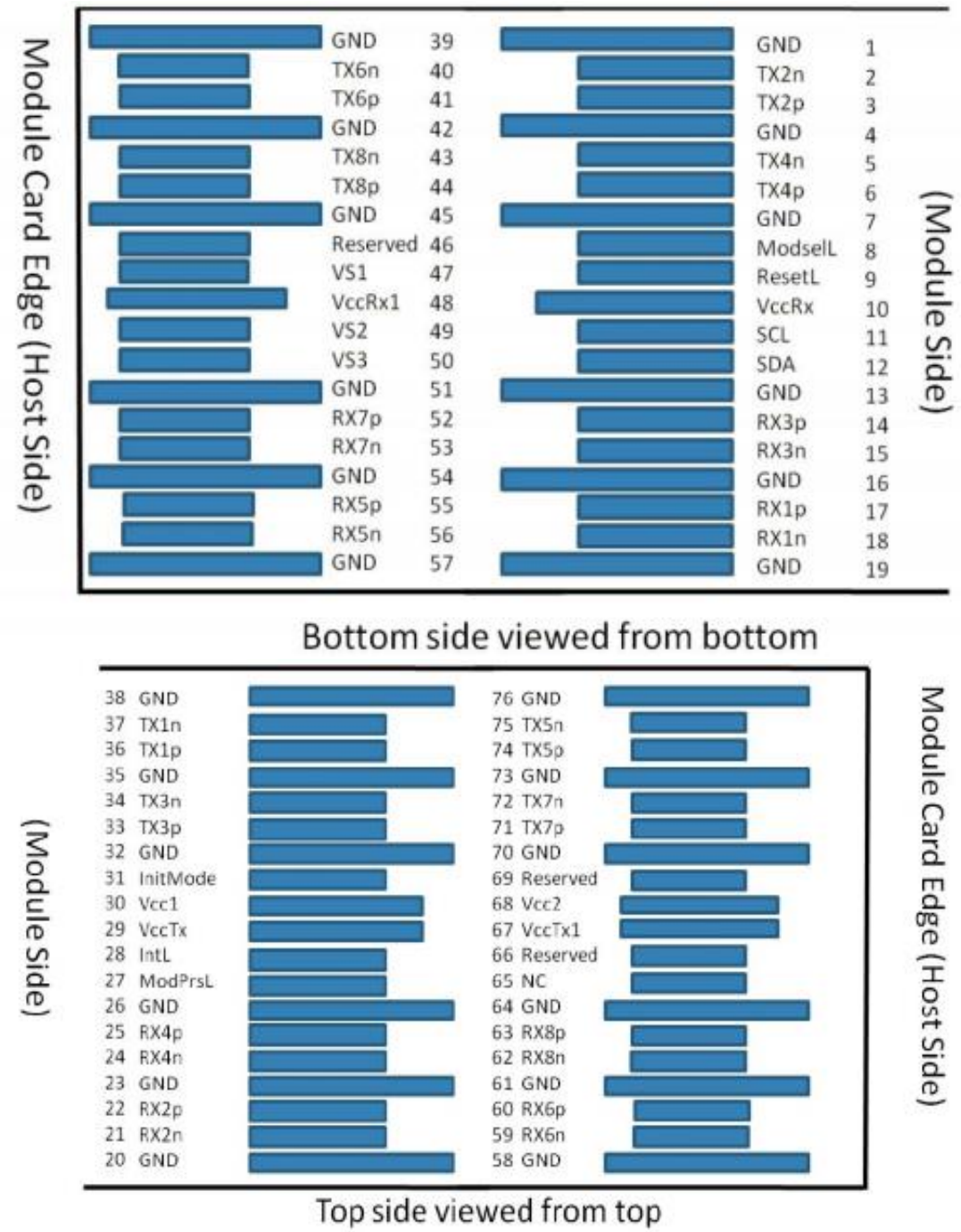
ELECTRICAL CHARACTERISTICS (High Speed Signal - Compliant with IEEE 802.3 400GAUI-8)

Parameter	Symbol	Min.	Typical	Max.	Unit	Note
TRANSMITTER (Module Input)						
Differential pk-pk input Voltage tolerance		900	-	-	mV	
Differential termination mismatch		-	-	10	%	
Single-ended voltage tolerance range		-0.4	-	3.3	V	
DC common mode Voltage		-350	-	2850	mV	
RECEIVER (Module Output)						
AC common-mode output Voltage (RMS)		-	-	17.5	mV	
Differential output Voltage		-	-	900	mV	
Near-end Eye height, differential		70	-	-	mV	
Far-end Eye height, differential		30	-	-	mV	
Far end pre-cursor ratio		-	-	2.5	%	
Differential Termination Mismatch		-	-	10	%	
Transition Time (min, 20% to 80%)		9.5	-	-	ps	
DC common mode Voltage		-350	-	2850	mV	

ELECTRICAL CHARACTERISTICS (Low Speed Signal - Compliant with QSFP-DD HW Rev 5.1)

Parameter	Symbol	Min.	Max.	Unit	Condition
Module output SCL and SDA	V_{OL}	0	0.4	V	
Module Input SCL and SDA	V_{IL}	-0.3	V_{CC}*0.3	V	
	V_{IH}	V_{CC}*0.7	V_{CC}+0.5	V	
InitMode, ResetL and ModSelL	V_{IL}	-0.3	0.8	V	
	V_{IH}	2	V_{CC}+0.3	V	
IntL	V_{OL}	0	0.4	V	
	V_{OH}	V_{CC}-0.5	V_{CC}+0.3	V	

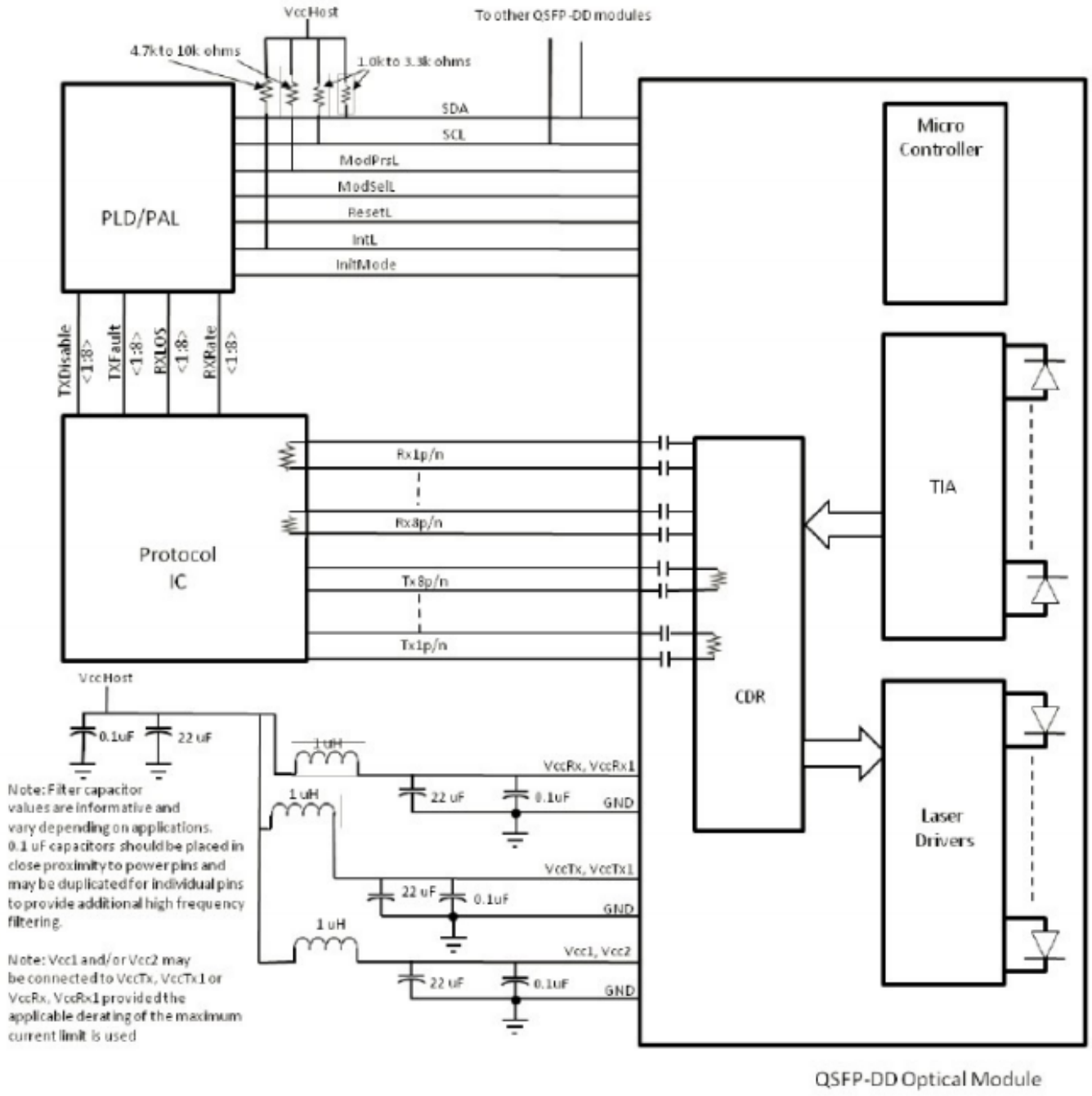
PIN ASSIGNMENT



Pin definitions of the module high speed inputs/outputs

Pin	Logic	Symbol	Definition	Pin	Logic	Symbol	Definition
1		GND	Ground	**39**		GND	Ground
2	CML-I	Tx2n	Transmitter Inverted Data Input	**40**	CML-I	Tx6n	Transmitter Inverted Data Input
3	CML-I	Tx2p	Transmitter Non-inverted Data Input	**41**	CML-I	Tx6p	Transmitter Non-inverted Data Input
4		GND	Ground	**42**		GND	Ground
5	CML-I	Tx4n	Transmitter Inverted Data Input	**43**	CML-I	Tx8n	Transmitter Inverted Data Input
6	CML-I	Tx4p	Transmitter Non-inverted Data Input	**44**	CML-I	Tx8p	Transmitter Non-inverted Data Input
7		GND	Ground	**45**		GND	Ground
8	LVTTL-I	ModSelL	Module Select	**46**		Reserved	
9	LVTTL-I	ResetL	Module Reset	**47**		VS1	Module Vendor Specific 1
10		VccRx	+3.3V Power Supply Receiver	**48**		VccRx1	3.3V Power Supply
11	LVCMOS-I/O	SCL	2-wire serial interface clock	**49**		VS2	Module Vendor Specific 2
12	LVCMOS-I/O	SDA	2-wire serial interface data	**50**		VS3	Module Vendor Specific 3
13		GND	Ground	**51**		GND	Ground
14	CML-O	Rx3p	Receiver Non-inverted Data Output	**52**	CML-O	Rx7p	Receiver Non-inverted Data Output
15	CML-O	Rx3n	Receiver Inverted Data Output	**53**	CML-O	Rx7n	Receiver Inverted Data Output
16		GND	Ground	**54**		GND	Ground
17	CML-O	Rx1p	Receiver Non-inverted Data Output	**55**	CML-O	Rx5p	Receiver Non-inverted Data Output
18	CML-O	Rx1n	Receiver Inverted Data Output	**56**	CML-O	Rx5n	Receiver Inverted Data Output
19		GND	Ground	**57**		GND	Ground
20		GND	Ground	**58**		GND	Ground
21	CML-O	Rx2n	Receiver Inverted Data Output	**59**	CML-O	Rx6n	Receiver Inverted Data Output
22	CML-O	Rx2p	Receiver Non-inverted Data Output	**60**	CML-O	Rx6p	Receiver Non-inverted Data Output
23		GND	Ground	**61**		GND	Ground
24	CML-O	Rx4n	Receiver Inverted Data Output	**62**	CML-O	Rx8n	Receiver Inverted Data Output
25	CML-O	Rx4p	Receiver Non-inverted Data Output	**63**	CML-O	Rx8p	Receiver Non-inverted Data Output
26		GND	Ground	**64**		GND	Ground
27	LVTTL-O	ModPrsL	Module Present	**65**		NC	Not connected
28	LVTTL-O	IntL	Interrupt	**66**		Reserved	
29		VccTx	+3.3V Power Supply Transmitter	**67**		VccTx1	3.3V Power Supply
30		Vcc1	+3.3V Power Supply	**68**		Vcc2	3.3V Power Supply
31	LVTTL-I	InitMode	Initialization mode	**69**		Reserved	
32		GND	Ground	**70**		GND	Ground
33	CML-I	Tx3p	Transmitter Non-inverted Data Input	**71**	CML-I	Tx7p	Transmitter Non-inverted Data Input
34	CML-I	Tx3n	Transmitter Inverted Data Input	**72**	CML-I	Tx7n	Transmitter Inverted Data Input
35		GND	Ground	**73**		GND	Ground
36	CML-I	Tx1p	Transmitter Non-inverted Data Input	**74**	CML-I	Tx5p	Transmitter Non-inverted Data Input
37	CML-I	Tx1n	Transmitter Inverted Data Input	**75**	CML-I	Tx5n	Transmitter Inverted Data Input
38		GND	Ground	**76**		GND	Ground

RECOMMENDED HOST BOARD



Recommended QSFP-DD Host Board Schematic

TIMING FOR SOFT CONTROL & STATUS FUNCTIONS

Parameter	Symbol	Min.	Max.	Unit	Notes
MgmtInit Duration		-	2000	ms	
ResetL Assert Time	t_reset_init	10	-	μs	
IntL Assert Time	ton_IntL	-	200	ms	
IntL Deassert Time	toff_IntL	-	500	μs	
Rx LOS Assert Time (fast mode)	ton_losf	-	1	ms	
Rx LOS Deassert Time (fast mode)	toff_losf	-	3	ms	
Tx Fault Assert Time	ton_Txfault	-	200	ms	
Flag Assert Time	ton_flag	-	200	ms	
Mask Assert Time	ton_mask	-	100	ms	
Mask Deassert Time	toff_mask	-	100	ms	
Module Select Wait Time	ModSelL Wait Time	-	N/A		

I/O TIMING FOR SQUELCH & DISABLE

Parameter	Symbol	Min.	Max.	Unit	Notes
Rx Squelch Assert Time	ton_Rxsq	-	15	ms	
Rx Squelch Deassert Time	toff_Rxsq	-	1500	ms	Depends on DSP timing
Tx Squelch Assert Time	ton_Txsq	-	400	ms	
Tx Squelch Deassert Time	toff_Txsq	-	1500	ms	Depends on DSP timing
Tx Disable Assert Time (fast mode)	ton_Txdisf	-	3	ms	
Tx Disable Deassert Time (fast mode)	toff_Txdisf	-	10	ms	
Rx Output Disable Deassert Time	toff_Rxdis	-	100	ms	
Rx Output Disable Assert Time	ton_Rxdis	-	100	ms	
Squelch Disable Assert Time	ton_sqdis	-	N/A	ms	Not support
Squelch Disable Deassert Time	toff_sqdis	-	N/A	ms	Not support

DIGITAL DIAGNOSTICS

Parameter	Range	Accuracy	Unit	Calibration
Temperature	0 to 70	±3	ºC	Internal
Voltage	0 to V_{CC}	0.1	V	Internal
Tx Bias Current (Each Lane)	0 to 100	10%	mA	Internal
Tx Output Power (Each Lane)	-2.8 to +5.3	±3	dB	Internal
Rx Receive Power (Each Lane)	-9.1 to +5.3	±3	dB	Internal

MECHANICAL SPECIFICATIONS (UNIT: mm)